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## **Irradiation effect on trapping time** of silicon carbide detector

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- Top-TCT on SiC PIN
- Trapping time and RASER simulation
- Irradiation effect
- Summary and Plan

#### SiC PIN



Au 1um	Passivation laver	Au 1um
	Ni 75nm	
	Imp P+	
	100um N- epi	
1.1	350um N+ 4H-SiC sub	
	Ni 75nm	
	Ti/Al/Au 1.5um	

Cross section of PIN

- 5mm×5mm SiC PIN detector fabricated by Nanjing University
- 100µm high resistive active epitaxy layer and 350µm substrate

• 
$$N_{eff} = 5.2 \times 10^{13} \text{cm}^{-3}, V_{dep} = 484 \text{V}$$
  $N_{eff} = \frac{2}{q \epsilon A^2 d(1/C^2)/dV}$   $V_{dep} = \frac{q |N_{eff}| d^2}{2\epsilon}$ 

Published: Time Resolution of the 4H-SiC PIN Detector https://doi.org/10.3389/fphy.2022.718071

## Experimental setup



Experimental set-up



Circuit diagram of readout

- 355nm laser is used to focus on the top surface of sic detector for top-TCT.
- Design the circuit according to UCSC board and change R1 from 475Ω to 4000Ω.
  <a href="https://twiki.cern.ch/twiki/bin/view/Main/UcscSingleChannel">https://twiki.cern.ch/twiki/bin/view/Main/UcscSingleChannel</a>
  <a href="https://indice.cern.ch/event/1132520/contributions/51/49453/attachments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20for%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/2556919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/4406364/SiC%20heam%20ments/256919/440640ments/256919/440640ments/256919/4406400ments/25691000ments/256

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#### Charge collection and trapping time

• Collected charge: Q=I·t



• Trapping time: 
$$Q = \frac{\Delta Q}{\delta x} \cdot D \cdot \frac{1}{D} \cdot v \cdot \tau = \frac{\Delta Q}{\delta x} \cdot v \cdot \tau$$

 $\frac{\Delta Q}{\delta x}$ : charge per unit track length

v: sum of electron and hole velocities.

#### **RASER** simulation

• RASER, fast simulation tool for time resolution of planar and 3D SiC PIN.

Time Resolution of the 4H-SiC PIN Detector https://doi.org/10.3389/fphy.2022.718071

Timing Performance Simulation for 3D 4H-SiC Detector https://www.mdpi.com/2072-666X/13/1/46

- Update:
  - DEVSIM for IV/CV and field distribution

https://indico.cern.ch/event/1132520/contributions/5149103/attachments/2556958/4406436/Xiyuan%20Zhang 41st rd50 workshop.pdf

• electronic circuits optimization

NGSpice to simulate electronic circuits

- convert the preamplifier circuits into the code as input
- output voltage after signal simulation

#### Charge collection from RASER



- Simulated charge collection shows good agreement with experiment result.  $V_{dep} = 484V$ .
- Further measurement is needed for the precise laser intensity.

#### Waveform comparison



- Put trapping time in simulation, waveform shows same trend with experiment result.
- The tail of descending edge may result from the cable capacitance.

#### Irradiation at CSNS

• Irradiation of SiC PIN is finished at China Spallation Neutron Source(CSNS).



Irradiation setup

- Particle: proton
- Energy: 80MeV
- Intensity: 10mA
- Area: 20mm×20mm
- Dose:  $3.9 \times 10^{13} n_{eq}/cm^2$ ,  $7.8 \times 10^{14} n_{eq}/cm^2$
- Temperature and humidity: No control

### Charge and trapping time for irradiation

• Defects caused by irradiation make charge carriers more easily captured during transport, thereby affecting the trapping time.



• Trapping time and log(irradiation dose) show good linear distribution.

#### Simulation for irradiation

• Change trapping time after irradiation to research waveform



• RASER simulation of irradiated detectors shows good agreement with experiment.

#### Summary and Plan

- ✓ RASER program has been updated on field calculation and readout electronics. Waveform and charge collection show good agreement.
- Trapping time works as an essential parameter for RASER simulation. Trapping time and log(irradiation dose) show good linear distribution.
- ≥ 2 more irradiation points will be added to check the linear distribution,  $1 \times 10^{11} n_{eq}/cm^2$ , and  $1 \times 10^{12} n_{eq}/cm^2$ .
- Further study is needed for cable capacitance in electronic simulation, which causing the difference at the tail of descending edge.
- > DLTS analysis will be completed for deeper understanding of defect.

# Thanks for your attention.







IV curve after irradiation